



Korea National NanoFab Center recognizes EV Group with Supplier Excellence Award – February 8, 2022



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## Top Stories

### [Amazon AWS is Intel Foundry Services first EMIB packaging customer?](#)

An interesting confluence of events has occurred in the last few months, starting with the announcement at the Intel Accelerated event in July that Amazon would be one of Intel Foundry Services (IFS) first customers, specifically for packaging. [More>>](#)



### [2022 SVC TechCon Happening in Long Beach!](#)

The text is: Join us at the Society of Vacuum Coaters 65th Annual Technical Conference and Exhibition, April 30 – May 5, 2022 at the Long Beach Convention Center, Long Beach, California. Come to the largest exhibition on vacuum coating technology. Attend a tutorial. Hear international technology news. Free one day pass on May 3 or 4. [Learn more.](#)

## Tech News

### [Tempo Automation accelerates EUV Tech's time-to-market by streamlining prototyping](#)

Tempo Automation today announced that EUV Tech has dramatically improved program time for its new tools by working with Tempo to build its Printed Circuit Board Assemblies (PCBAs) faster than ever before. [More>>](#)



The January/February issue  
of the magazine is now  
available!  
Exclusive Articles!  
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## Featured Video

CyberOptics' new WX3000 Metrology and Inspection system, which Incorporates the company's NanoResolution Multi-Reflection Suppression™ (MRS™) sensor, enables the combination of high speed, high resolution and high accuracy for wafer-level and advanced packaging. At SEMICON West, **Subodh Kulkarni, President and CEO**, explains how it works and what's new in the company's other product lines.



## Business News

### [Korea National NanoFab Center recognizes EV Group with Supplier Excellence Award](#)

EV Group (EVG) today announced that it has received a Supplier Excellence Award from the Korea National NanoFab Center (NNFC), a nano-technology R&D infrastructure for academia, research institutes and the industry. [More>>](#)

### [GOWIN Semiconductor appoints WPG as pan-European distributor](#)

GOWIN Semiconductor Corp., the world's fastest-growing programmable logic company, today announces a new strategic partnership by appointing WPG EMEA, part of WPG Holdings, the world's largest semiconductor distributor, as a pan-European distributor. [More>>](#)

### [Arm appoints Rene Haas as Chief Executive Officer](#)

Arm announced today that its board of directors has appointed 35-year semiconductor industry leader Rene Haas as chief executive officer and member of the board of directors, effective immediately. [More>>](#)

## **Webcasts and Technology Papers**

**New Continuous Improvement Opportunities for Semiconductor Technologies  
Entering the Automotive Domain**

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Engineering**

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**Consistent Atomic Layer Deposition Processes Demand Consistent  
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**Analysis of Metallic Impurities in Organic Solvents Used in IC Fabrication With the  
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**Backside Protection of Wafer-Level Chip Scale Packages Improves Handling and  
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**Ultra-Trace Quantification of Non-Metals in Sulfuric Acid Solutions Using the NexION 5000 ICP-MS Under Different Cell Gas Conditions**

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**In-line Airborne Particle Sensing Supports Faster Response to Contamination Excursions**

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